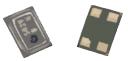
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Product Specification ML-4259-2314-T1L1 Top-port analog silicon microphone



Description

ML-4259-2314-T1L1 is miniature, high-performance analog top-port analog silicon microphone that receives the sound signal from the topside hole on lid. By using our own innovative and unique MEMS silicon microphone chip design, MicroLink Senstech provides a series of packaged MEMS silicon microphones with compact size to achieve high performance such as high SNR, high sensitivity, excellent reliability and broad frequency response. This series of MEMS microphones find wide applications in cell phones, tablets, wearable devices and other portable electronic devices.

The ML-4259-2314-T1L1 has a sensitivity of -42dBV/Pa(tolerance of ± 1 dBV/Pa) with a signal-to-noise ratio of 59 dB, an extreme low total harmonic distortion of 0.1% at 94 dB SPL and very high acoustic overload point of 132 dB SPL.

• Features

- \succ Gold coated metal housing package, immune to RF/EM interference.
- High mechanical strength, high temperature resistance and excellent reliability.
- > Wide frequency response range, high sensitivity and pretty good signal-tonoise ratio.
- \succ Withstand multiple times of SMT reflow process.



• Applications

 $Learning \ machines/game \ stations, \ MP3/DC/DV, Bluetooth \ headsets/headphones, \ we arable$

smart systems, etc.



• Absolute maximum ratings

Supply voltage: VDD to GND $-0.3V\!\sim\!5V$

- ESD Tolerance

Temperature Characteristics					
Parameter Conditions			Тур	Max	Unit
Operating Temperature		-40		+85	°C
Store to Tome enotions	Solder on PC board	-40		+105	°C
Storage Temperature	In Tape and Reel	-10		+50	°C





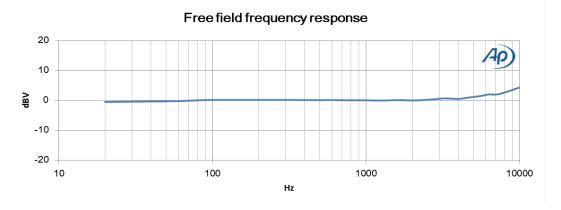
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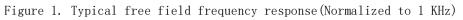
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Parameter	Symbol	Condition	Min.	Тур.	Max	Unit
Sensitivity	Sens	94dB SPL @1kHz	-43	-42	-41	dBV/Pa
Signal to Noise Ratio	SNR	20Hz to 20KHz,A- weighted	-	59	-	dB (A)
Output Impedance	$\mathrm{Z}_{\mathrm{out}}$	@ 1 kHz	_	_	200	Ω
Supply Voltage	V_{DD}		1.6	-	3.6	V
Current Consumption	I_{DD}		-	110	135	μA
Dimension			$2.30 \times 1.40 \times 1.00$			mm
Directivity			Omnidirectional			
Frequency Response	F		20~16k		Hz	
Power Supply Rejection	PSR	217Hz,0.1Vpp Square on VDD	_	-98	_	dBV (A)
Power Supply Rejection Ratio	PSRR	200mVpp sinewave @ 1 kHz	_	68	-	dB
Total Harmonic	THD	94 dB SPL @ 1kHz	Ι	0.1	-	%
Distortion		114 dB SPL @ 1kHz	Ι	0.5	_	%
Acoustic	AOP	1% THD @ 1kHz	_	129	_	dB SPL
Overload Point	AUI	10% THD @ 1kHz		132		dB SPL

• Acoustic and electrical specifications

Frequency response







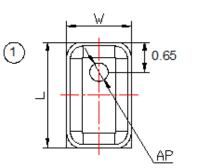
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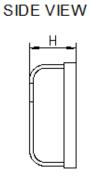
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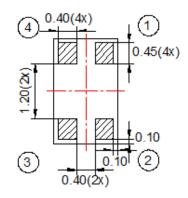
• Mechanical specifications

TOP VIEW





BOTTOM VIEW



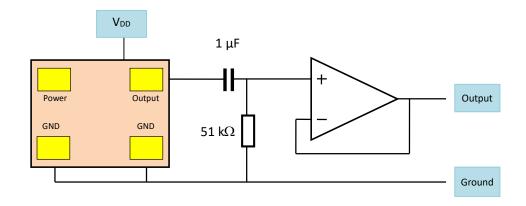
Item	Dimension	Tolerance	Unit	Pin#	
Length(L)	2.30	±0.1	mm	1	
With(W)	1.40	±0.1	mm	2	
Hight(H)	1.00	±0.1	mm	3	
Acoustic Port (AP)	Ø0.40	±0.05	mm	4	

1#	Pin Name
1	Output
2	GND
3	GND
4	VDD

Notes:Dimensions are millimeters otherwise specified. Tolerance is ±0.1mm unless otherwise specified.

Figure 2. Detailed mechanical	drawings
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• Block diaphragm





• Example Land Pattern

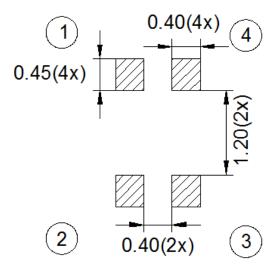
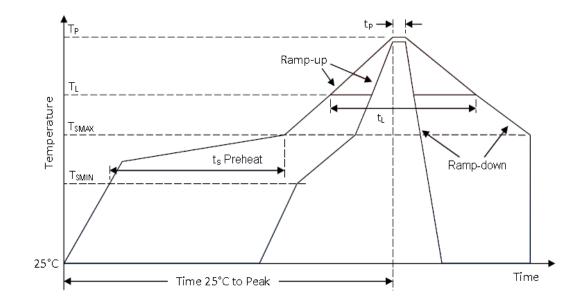


Figure 3. Recommended landing pattern on customers' PCB





• Recommended Reflow profile

Description		Parameter (lead-free)	
Average temperature change rate $(T_{SMAX}$ to $T_P)$		3ºC/second max.	
	Minimum temperature (T _{SMIN})	150°C	
Preheat	Maximum temperature (T_{SMAX})	200°C	
	Time (T_{SMIN} to T_{SMAX}) (t _s)	60-180 seconds	
Reflow	Temperature (T _L)	217°C	
	Time (t_1)	60-150 seconds	
Deals toma anotica	Temperature (T _P)	260°C	
Peak temperature	Time (t _P)	20-40 seconds	
Cooling rate(T_P to T_{SMAX})		6ºC/second max	
Time required from 25°C to peak temperature		8 minutes max	

Figure 4. Recommended leadless solder reflow temperature profile

Notes:

- 1) The air speed during reflow process should be low to avoid impurity entering the acoustic hole during reflow process.
- 2) Do not wash or clean the product to avoid impurity entering the product.
- 3) Do not carry out the reflow process more than 5 times. If the melting point of solderis lower, the peak temperature should be accordingly reduced.



ESD-HBM

ESD-HBM

ESD-MM

Vibration test

Reflow test

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Test Item Description Temperature/Humidity Bias 168 hours at +85°C/85% R.H. under bias (JESD22-A101A-B) 100 cycles air-to-air thermal shock from -40°C to +125°C Thermal shock with 15minute soaks. (IEC 68-2-4) 168 hours at +105°C environment(IEC 68-2-2) High Temperature Storage Low Temperature Storage 168 hours at -40°C environment(IEC 68-2-1) Using 150g fixture, 3 drops along each of 6 axes from Drop test 1.5m height onto slippery marble floor(IEC 68-2-27)

3 discharges of ± 2 kV direct contact to I/O pins. (MIL

3 discharges of ± 8 kV direct contact to lid while unit

3 discharges of ± 200 V direct contact to I/O pins.

4 cycles of 20 to 2,000 Hz sinusoidal sweep with 20 G

peak acceleration lasting 12 minutes in X, Y, and Z

directions (Mil-Std-883E, Method 2007.2 A)

5 reflow cycles with peak temperature of +260 °C

Reliability Specifications

Notes: After reliability tests are performed, the sensitivity of the microphones shall
not deviate more than 3 dB from its initial value. After 3 reflow cycles, the
sensitivity of the microphone shall not deviate more than 3dB from its initial value.

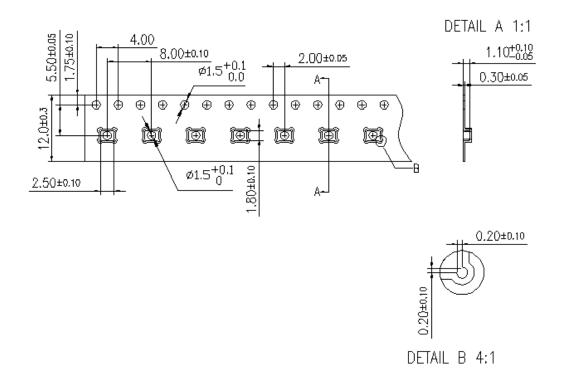
883E, Method 3015.7)

(ESD STM5.2)

is grounded. (IEC 61000-4-2)



• Packaging and marking detail



Model Number	Reel Diameter	Quantity Per Reel	Quantity Per Carton
ML-4259-2314-T1L1	13″	5,000	5,000 * 10 =50,000Pcs

Notes:

- Dice are packaged in black carrier band which uses anti-electrostatic material. Each volume of packaged products is 5000 pcs.
- 2) The space between two dice is 8mm packaged in the carrier band with 12-mm width rolled in the reel of 13-inch diameter.
- 3) The first 50 pcs and the last 20 pcs are vacant.
- 4) The package requirements mentioned below is the company's standard delivery specifications. If you need special packages, please contact our sales staff.
- 5) All dimensions are in millimeters (mm) with tolerance of \pm 0.3mm.



• Materials Statement

- \succ Meets the requirements of the European RoHS directive 2011/65/EC as amended.
- Meets the requirements of the industry standard IEC 61249-2-21:2003 for halogenated substances and SV SensTech Green Materials Standards Policy section on Halogen-Free.

• Remarks

- ➤ (A) MSL (moisture sensitivity level) Class 1.
- > (B) Maximum of 3 reflow cycles is recommended.
- > (C) In order to minimize device damage:
 - Do not board wash or clean after the reflow process.
 - Do not brush board with or without solvents after the reflow process.
 - Do not directly expose to ultrasonic processing, welding, or cleaning.
 - Do not insert any object in port hole of device at any time.
 - Do not apply over 30 psi of air pressure into the port hole.
 - Do not pull a vacuum over port hole of the microphone.
 - Do not apply a vacuum when repacking into sealed bags at a rate faster than 0.5 atm/sec.



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• Version updates

Version	Updated Content	Updated Date
1.0	Initial release	2020-01-17

• Contact

SV SensTech Co.,Ltd

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